

# **General-Purpose Rectifiers**

## **S1A - S1M**

## **Description**

In the world of commodity rectifiers, **onsemi** S1 family of 1 A, P–I–N, SMA rectifiers stand out for their optimized low leakage, low capacitance, and fast response time. This was achieved while maintaining the industry standard  $V_F$  max of 1.1 V at 1 A and a 30 A surge rating. In today's world, where system power efficiency is a critical differentiating feature, these advantages can be leveraged to support those higher efficiency goals.

## Features

- 1 AI<sub>F(AV)</sub> Current Rating
- Glass Passivated
- Low Leakage:
  - 1 μA Maximum at 25°C
  - 50 μA Maximum at 125°C
- Fast Response: 1.8 μs (Typical)
- 30 A Surge Rating
- 50 V to 1000 V Reverse Voltage Ratings
- 6.6 pF Typical Capacitance
- UL Certified, UL #E258596
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant





SMA CASE 403AE

#### **MARKING DIAGRAM**



= Assembly Plant Code

X = Last Digit of Year of Manufacture
YY = Weekly Code of Manufacture

DDDD = Specific Device Code

## **ORDERING INFORMATION**

Part Number	Device Code Marking	Package	Shipping <sup>†</sup>
S1A	S1A	DO-214AC (SMA)	7500 / Tape & Reel
S1B	S1B	(Pb-Free)	7500 / Tape & Reel
S1D	S1D	1 [	7500 / Tape & Reel
S1G	S1G	1 [	7500 / Tape & Reel
S1J	S1J	1 [	7500 / Tape & Reel
S1K	S1K	] [	7500 / Tape & Reel
S1M	S1M		7500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted) (Note 1)

		Value							
Symbol	Parameter	S1A	S1B	S1D	S1G	S1J	S1K	S1M	Unit
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Rectified Forward Current at T <sub>A</sub> = 100°C	1.0				А			
I <sub>FSM</sub>	Non-Repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	30			Α				
T <sub>STG</sub>	Storage Temperature Range	−55 to +150			°C				
TJ	Operating Junction Temperature	−55 to +150			°C				

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
P <sub>D</sub>	Power Dissipation	1.4	W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 2)	85	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 3)	170	°C/W
$\Psi_{JL}$	Junction-Lead Thermal Characteristics (Note 3)	25	°C/W

<sup>2.</sup> Device mounted on FR-4 PCB, land pattern size: 25 mm<sup>2</sup> (5 x 5 mm).

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 1.0 A	-	-	1.1	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A I <sub>rr</sub> = 0.25 A	-	1.8	-	μs
I <sub>R</sub>	Reverse Current at Rated V <sub>R</sub>	T <sub>A</sub> = 25°C	-	-	1.0	μΑ
		TA = 125°C	-	-	50	
CJ	Junction Capacitance	V <sub>R</sub> = 4.0 V, f = 1.0 MHz	-	6.6	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>1.</sup> These ratings are limiting values above which the serviceability of any semiconductor device maybe impaired.

<sup>3.</sup> Device mounted on FR-4 PCB, land pattern size: 4.6375 mm<sup>2</sup> (2.65 x 1.75 mm).

## TYPICAL PERFORMANCE CHARACTERISTICS

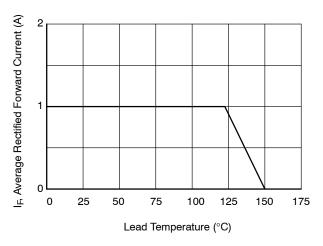
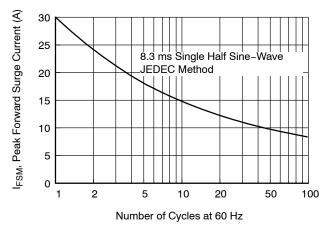


Figure 1. Forward Current Derating Curve

Figure 2. Forward Voltage Characteristics



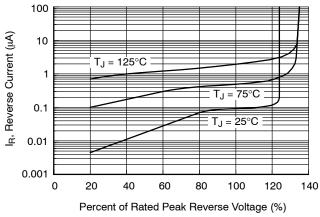
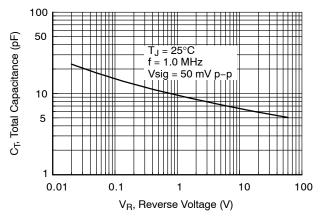


Figure 3. Non-Repetitive Surge Current

Figure 4. Reverse Current vs. Reverse Voltage



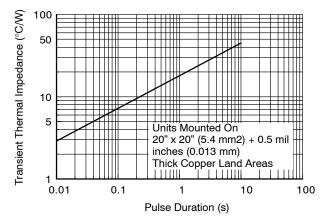


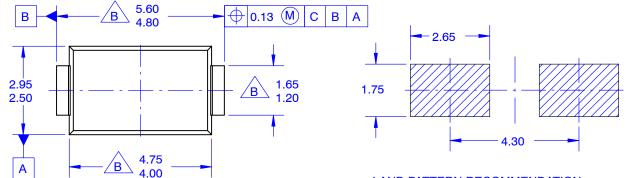
Figure 5. Total Capacitance

Figure 6. Thermal Impedance Characteristics



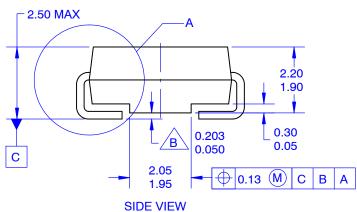
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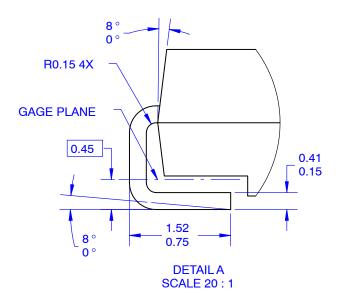
**TOP VIEW** 

LAND PATTERN RECOMMENDATION



#### NOTES:

- A. EXCEPT WHERE NOTED, CONFORMS ^ TO JEDEC DO214 VARIATION AC.
- B DOES NOT COMPLY JEDEC STANDARD VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSIONS AND TOLERANCE AS PER ASME Y14.5–2009.
- E. LAND PATTERN STD. DIOM5025X231M



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